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FCPF11N60F

FAIRCHILD

# N-Channel SuperFET<sup>®</sup> FRFET<sup>®</sup> MOSFET

600 V, 11 A, 380 m $\Omega$ 

# Features

- 600 V @ T<sub>J</sub> = 150°C
- Typ. R<sub>DS(on)</sub> = 320 mΩ
- Fast Recovery Type (t<sub>rr</sub> = 120 ns)
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 40 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 95 pF)
- 100% Avalanche Tested
- RoHS compliant

# Applications

LCD/LED/PDP TV

Lighting

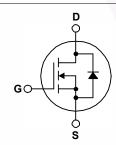
Solar InverterAC-DC Power Supply

## Description

SuperFET<sup>®</sup> MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. Super-FET FRFET<sup>®</sup> MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

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TO-220F



### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter			FCPF11N60F	Unit	
V <sub>DSS</sub>	Drain to Source Voltage			600	V	
	Drain Current	- Continuous (T <sub>C</sub> = 25	°C)	11*		
ID	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		7*	— A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	33*	A	
V <sub>GSS</sub>	Gate to Source Voltage			±30	V	
E <sub>AS</sub>	Single Pulsed Avalanche	e Energy	(Note 2)	340	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	11	А	
E <sub>AR</sub>	Repetitive Avalanche Er	nergy	(Note 1)	12.5	mJ	
dv/dt	Peak Diode Recovery d	v/dt	(Note 3)	4.5	V/ns	
P <sub>D</sub> Powe	Dewer Dissignation	(T <sub>C</sub> = 25 <sup>o</sup> C)		36	W	
	Power Dissipation	- Derate Above 25°C		0.29	W/ <sup>o</sup> C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds				300	°C	

### Thermal Characteristics

Symbol	Parameter	FCPF11N60F	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W

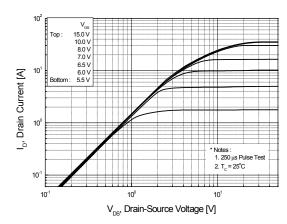
#### November 2013

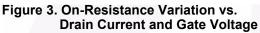
Device Ma	rking	Device	Pack	age	Reel Size	Тар	e Width		Quantit	у
FCPF11N	160F	FCPF11N60F	TO-2	20F	-		-		50	
Electrica	l Char	acteristics T <sub>c</sub> =	25°C unles	s otherw	ise noted					
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	s							1	
				Vaa	= 0 V, I <sub>D</sub> = 250 µA, T <sub>C</sub>	- 25 <sup>0</sup> C	600		-	V
BV <sub>DSS</sub>	Drain to	o Source Breakdown V	oltage		= 0 V, I <sub>D</sub> = 250 μA, T <sub>C</sub> = 0 V, I <sub>D</sub> = 250 μA, T <sub>C</sub>		-	- 650	-	V
∆BV <sub>DSS</sub>	Breakd	own Voltage Temperat					-	050	-	v
ΔΒV <sub>DSS</sub> /ΔTJ	Coeffic		uie	I <sub>D</sub> = 2	50 µA, Referenced to	o 25ºC	-	0.6	-	V/ºC
BV <sub>DS</sub>		Source Avalanche Brea	kdown	V -	-0.1/1 - 11.0			700		V
50	Voltage				= 0 V, I <sub>D</sub> = 11 A		-	700	-	V
	Zero G	ate Voltage Drain Curr	ent	_	= 600 V, V <sub>GS</sub> = 0 V		-	-	1	μA
DSS	2010 0	ate voltage Drain our	CIII	-	= 480 V, T <sub>C</sub> = 125 <sup>o</sup> C		-	-	10	μA
IGSS	Gate to	Body Leakage Currer	nt	V <sub>GS</sub> =	= ±30 V, V <sub>DS</sub> = 0 V		-	-	±100	nA
On Charac	teristic	s								
V <sub>GS(th)</sub>	-1	hreshold Voltage		Vcs	= V <sub>DS</sub> , I <sub>D</sub> = 250 μA		3.0	_	5.0	V
R <sub>DS(on)</sub>		Frain to Source On Res	sistance		= 10 V, I <sub>D</sub> = 5.5 A		-	0.32	0.38	Ω
9FS		d Transconductance		00	= 40 V, I <sub>D</sub> = 5.5 A		_	6	-	S
	horoot	oriation		00						1
-	Input Capacitance				1148	1490	nE.			
C <sub>iss</sub>				V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		-	671	870	pF pF	
C <sub>oss</sub>		Capacitance e Transfer Capacitance				-	63	82	pr pF	
C <sub>rss</sub>		Capacitance	<del>.</del>		= 480 V, V <sub>GS</sub> = 0 V, f =	- 1 0 MU-	-	35	02	pr pF
C <sub>oss</sub>		e Output Capacitance			= 0 V to 400 V, $V_{GS}$ = 0 V, 1 =			95	-	pF
C <sub>oss(eff.)</sub>		ate Charge at 10V				0 0	-	40	52	nC
Q <sub>g(tot)</sub>		Source Gate Charge		$V_{\rm DS} = 480 \text{ V}, \text{ I}_{\rm D} = 11 \text{ A},$		-	7.2	52	nC	
Q <sub>gs</sub>		-		V <sub>GS</sub> ·	= 10 V	(Note 4)		21	-	nC
Q <sub>gd</sub>	Gale io	Drain "Miller" Charge				(11010-1)	-	21	-	lic
Switching	Charac	teristics								
d(on)	Turn-O	n Delay Time				-	34	80	ns	
t <sub>r</sub>	Turn-O	n Rise Time			V <sub>DD</sub> = 300 V, I <sub>D</sub> = 11 A,		-	98	205	ns
t <sub>d(off)</sub>	Turn-Of	f Delay Time		R <sub>G</sub> =	25 Ω		-	119	250	ns
ł	Turn-Of	f Fall Time		(Note 4)		-	56	120	ns	
Drain-Sour	ce Dio	de Characteristic	s							
Is	1	m Continuous Drain to		de Forw	ard Current		-	-	11	А
I <sub>SM</sub>	Maximu	m Pulsed Drain to Sou	urce Diode F	orward (	Current		-	-	33	Α
V <sub>SD</sub>	Drain to	Source Diode Forwar	d Voltage	V <sub>GS</sub> =	= 0 V, I <sub>SD</sub> = 11 A		-	-	1.4	V
t <sub>rr</sub>		e Recovery Time	0				-	120		ns
Q <sub>rr</sub>		e Recovery Charge		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 11 A, dI <sub>F</sub> /dt = 100 A/μs		-	0.8		μC	
lotes: . Repetitive rating: . I <sub>AS</sub> = 5.5 A, V <sub>DD</sub> . I <sub>SD</sub> ≤ 11 A, di/dt :	= 50 V, R <sub>G</sub> = ≤ 200 A/μs, V	limited by maximum junction = 25 $\Omega$ , starting T <sub>J</sub> = 25°C. V <sub>DD</sub> ≤ BV <sub>DSS</sub> , starting T <sub>J</sub> = 25 perating temperature.							~	

# Typical Performance Characteristics

### Figure 1. On-Region Characteristics

### Figure 2. Transfer Characteristics





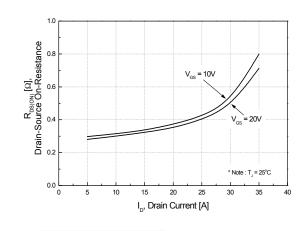
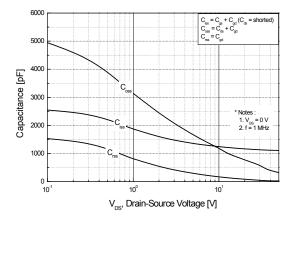
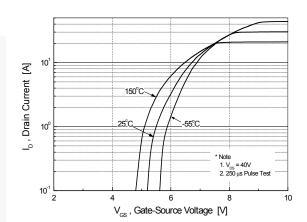


Figure 5. Capacitance Characteristics







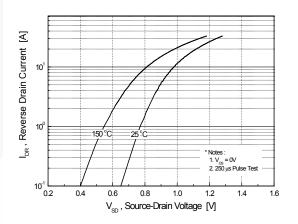
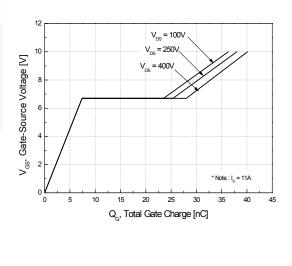
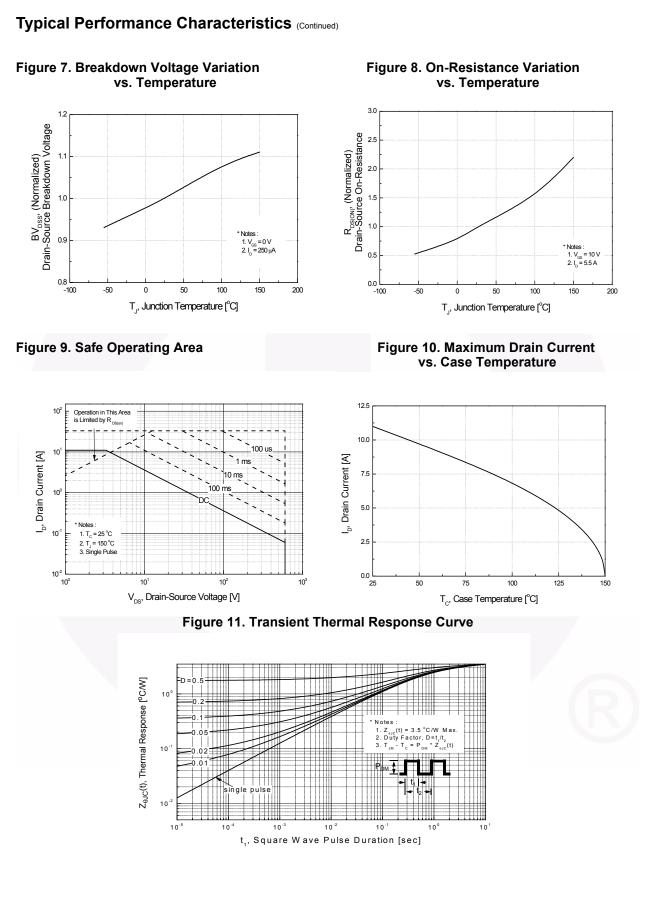
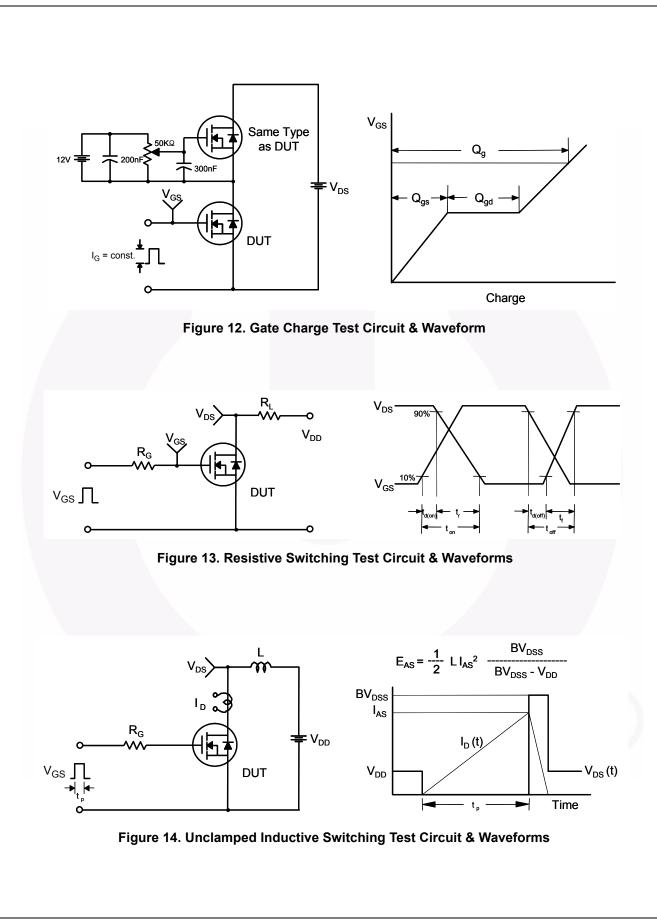


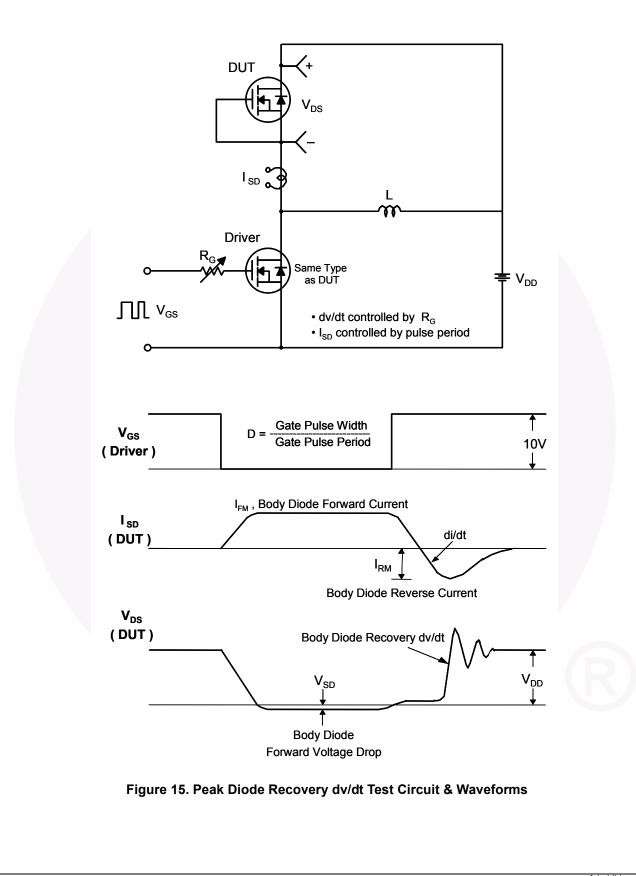
Figure 6. Gate Charge Characteristics



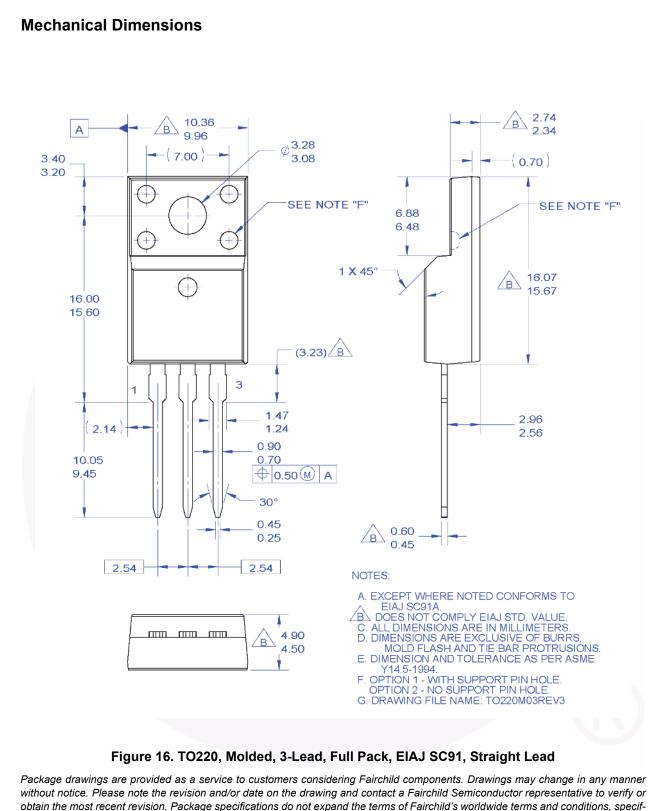




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